

PMN27UN

TrenchMOS™ ultra low level FET

Rev. 01 — 27 September 2002

Product data

1. Description

N-channel enhancement mode field-effect transistor in a plastic package using TrenchMOS™ technology.

Product availability:

PMN27UN in SOT457 (TSOP6).

2. Features

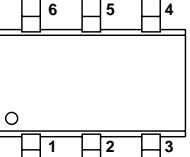
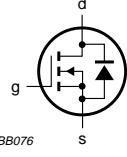
- TrenchMOS™ technology
- Very fast switching
- Low threshold voltage
- Surface mount package.

3. Applications

- Battery powered motor control
- Load switch in notebook computers
- High speed switch in set top box power supplies
- Driver FET in DC to DC converters.

4. Pinning information

Table 1: Pinning - SOT457 (TSOP6), simplified outline and symbol

Pin	Description	Simplified outline	Symbol
1,2,5,6	drain (d)		
3	gate (g)		
4	source (s)	 Top view MBK092	 MBB076



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5. Quick reference data

Table 2: Quick reference data

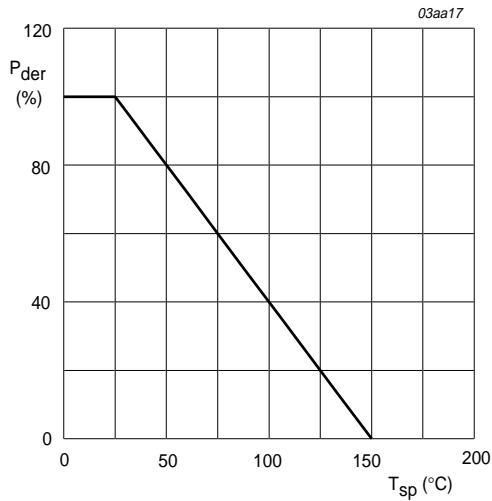
Symbol	Parameter	Conditions	Typ	Max	Unit
V_{DS}	drain-source voltage (DC)	$25^{\circ}\text{C} \leq T_j \leq 150^{\circ}\text{C}$	-	20	V
I_D	drain current (DC)	$T_{sp} = 25^{\circ}\text{C}; V_{GS} = 4.5\text{ V}$	-	5.7	A
P_{tot}	total power dissipation	$T_{sp} = 25^{\circ}\text{C}$	-	1.75	W
T_j	junction temperature		-	150	$^{\circ}\text{C}$
R_{DSon}	drain-source on-state resistance	$V_{GS} = 4.5\text{ V}; I_D = 2\text{ A}; T_j = 25^{\circ}\text{C}$	27	34	$\text{m}\Omega$
		$V_{GS} = 2.5\text{ V}; I_D = 2\text{ A}; T_j = 25^{\circ}\text{C}$	32	40	$\text{m}\Omega$
		$V_{GS} = 1.8\text{ V}; I_D = 1.5\text{ A}; T_j = 25^{\circ}\text{C}$	39	56	$\text{m}\Omega$

6. Limiting values

Table 3: Limiting values

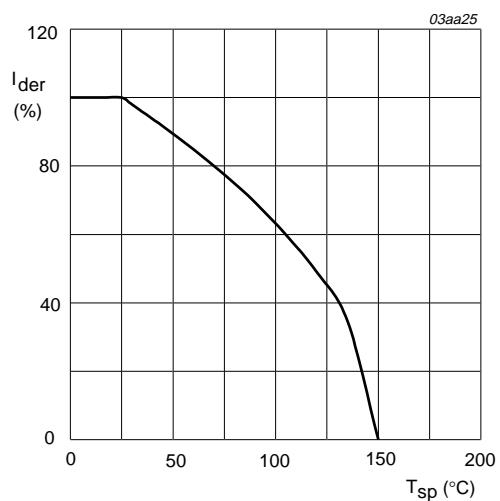
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage (DC)	$25^{\circ}\text{C} \leq T_j \leq 150^{\circ}\text{C}$	-	20	V
V_{GS}	gate-source voltage (DC)		-	± 8	V
I_D	drain current (DC)	$T_{sp} = 25^{\circ}\text{C}; V_{GS} = 4.5\text{ V};$ Figure 2 and 3	-	5.7	A
		$T_{sp} = 70^{\circ}\text{C}; V_{GS} = 4.5\text{ V};$ Figure 2	-	4.5	A
I_{DM}	peak drain current	$T_{sp} = 25^{\circ}\text{C};$ pulsed; $t_p \leq 10\text{ }\mu\text{s};$ Figure 3	-	22.9	A
P_{tot}	total power dissipation	$T_{sp} = 25^{\circ}\text{C};$ Figure 1	-	1.75	W
T_{stg}	storage temperature		-55	+150	$^{\circ}\text{C}$
T_j	junction temperature		-55	+150	$^{\circ}\text{C}$
Source-drain diode					
I_S	source (diode forward) current (DC)	$T_{sp} = 25^{\circ}\text{C}$	-	1.45	A



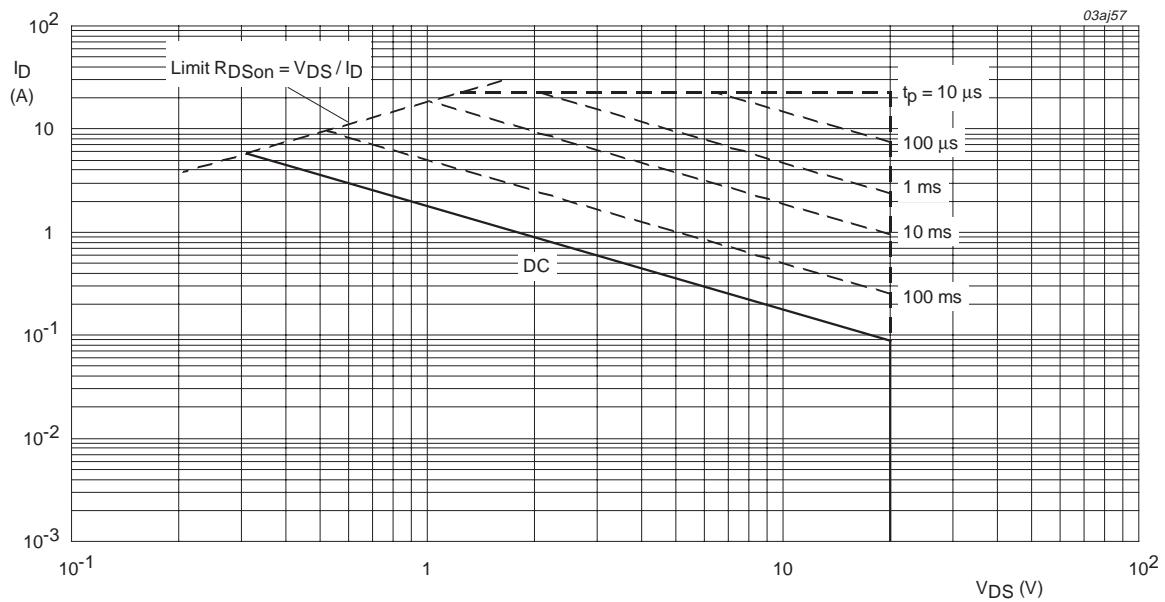
$$P_{der} = \frac{P_{tot}}{P_{tot}(25^\circ C)} \times 100\%$$

Fig 1. Normalized total power dissipation as a function of solder point temperature.



$$I_{der} = \frac{I_D}{I_{D(25^\circ C)}} \times 100\%$$

Fig 2. Normalized continuous drain current as a function of solder point temperature.



$T_{sp} = 25^\circ C$; I_{DM} is single pulse.

Fig 3. Safe operating area; continuous and peak drain currents as a function of drain-source voltage.

7. Thermal characteristics

Table 4: Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	mounted on a metal clad board; Figure 4	-	-	70	K/W

7.1 Transient thermal impedance

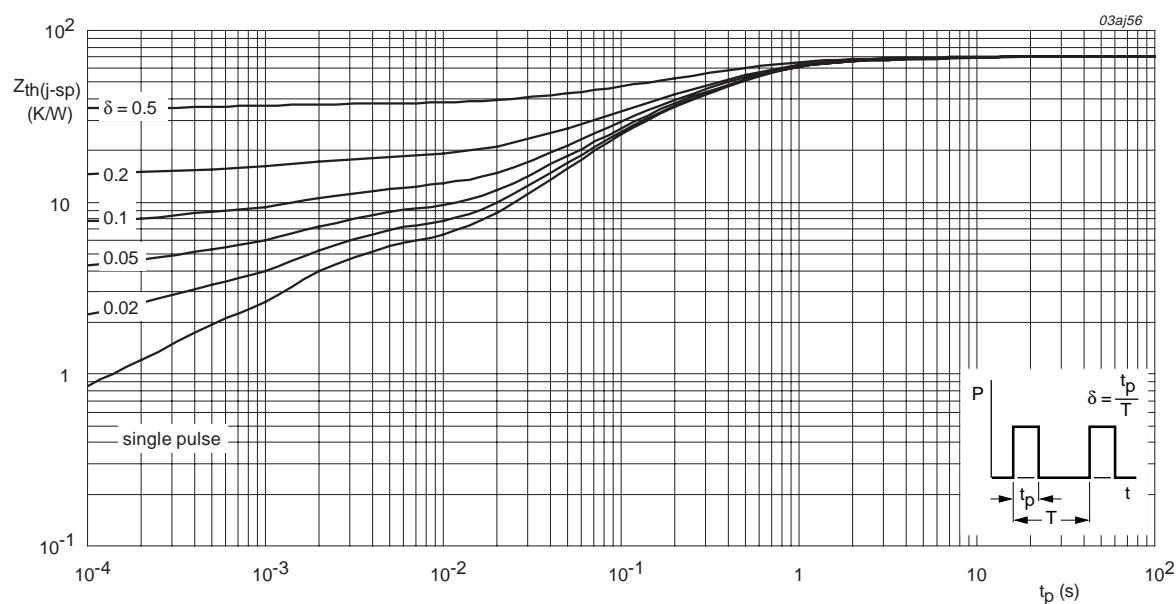
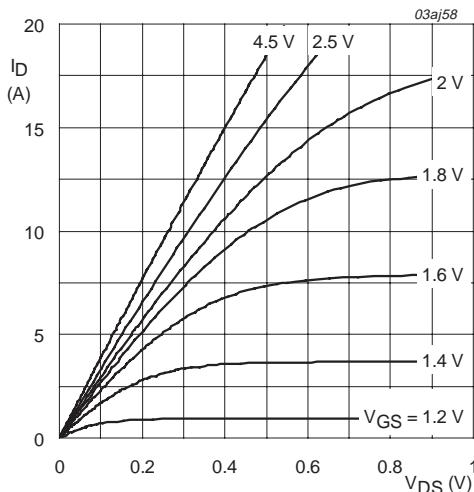


Fig 4. Transient thermal impedance from junction to solder point as a function of pulse duration.

8. Characteristics

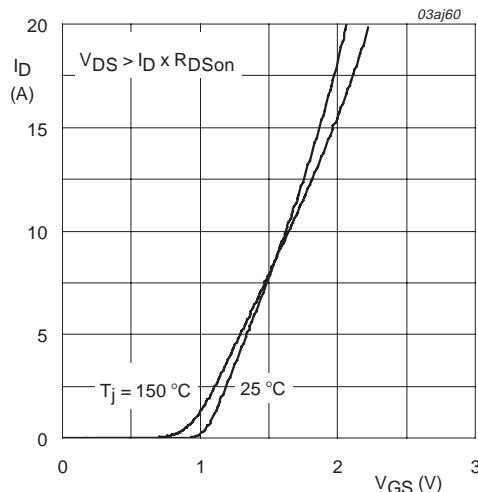
Table 5: Characteristics $T_j = 25^\circ\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(\text{BR})\text{DSS}}$	drain-source breakdown voltage	$I_D = 250 \mu\text{A}; V_{GS} = 0 \text{ V}$	20	-	-	V
$V_{GS(\text{th})}$	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}$; Figure 9	0.4	0.7	-	V
I_{DSS}	drain-source leakage current	$V_{DS} = 16 \text{ V}; V_{GS} = 0 \text{ V}$				
		$T_j = 25^\circ\text{C}$	-	0.01	1.0	μA
		$T_j = 55^\circ\text{C}$	-	-	10	μA
I_{GSS}	gate-source leakage current	$V_{GS} = \pm 8 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
$R_{DS\text{on}}$	drain-source on-state resistance	$V_{GS} = 4.5 \text{ V}; I_D = 2 \text{ A}$; Figure 7 and 8	-	27	34	$\text{m}\Omega$
		$V_{GS} = 2.5 \text{ V}; I_D = 2 \text{ A}$; Figure 7 and 8	-	32	40	$\text{m}\Omega$
		$V_{GS} = 1.8 \text{ V}; I_D = 1.5 \text{ A}$; Figure 7 and 8	-	39	56	$\text{m}\Omega$
Dynamic characteristics						
$Q_{g(\text{tot})}$	total gate charge	$V_{DD} = 10 \text{ V}; V_{GS} = 4.5 \text{ V}; I_D = 3.8 \text{ A}$; Figure 13	-	10.6	-	nC
Q_{gs}	gate-source charge		-	1.8	-	nC
Q_{gd}	gate-drain (Miller) charge		-	2.1	-	nC
C_{iss}	input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 10 \text{ V}; f = 1 \text{ MHz}$; Figure 11	-	740	-	pF
C_{oss}	output capacitance		-	185	-	pF
C_{rss}	reverse transfer capacitance		-	125	-	pF
$t_{d(\text{on})}$	turn-on delay time	$V_{DD} = 10 \text{ V}; R_D = 10 \Omega; V_{GS} = 4.5 \text{ V}; R_G = 6 \Omega$	-	8.5	-	ns
t_r	rise time		-	14.5	-	ns
$t_{d(\text{off})}$	turn-off delay time		-	55	-	ns
t_f	fall time		-	16	-	ns
Source-drain diode						
V_{SD}	source-drain (diode forward) voltage	$I_S = 1.7 \text{ A}; V_{GS} = 0 \text{ V}$; Figure 12	-	0.8	1.2	V



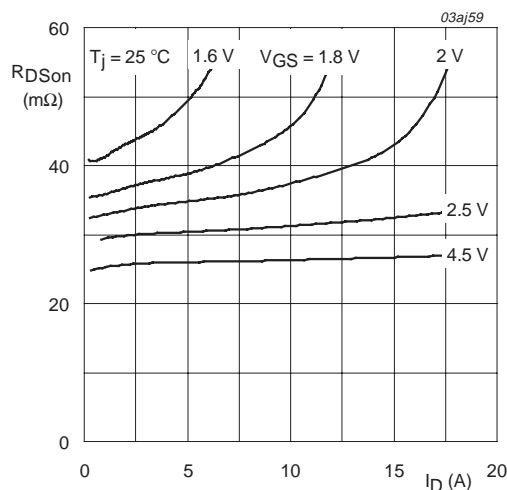
$T_j = 25^\circ\text{C}$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values.



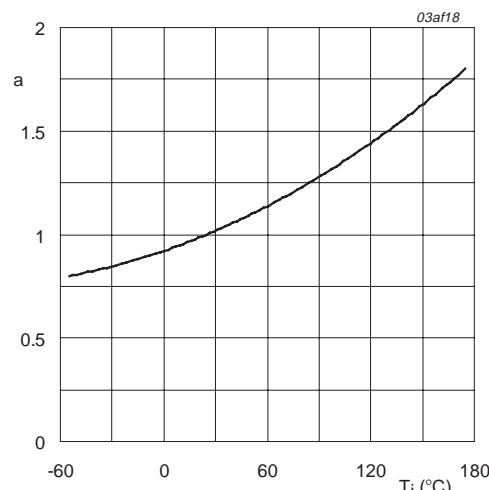
$T_j = 25^\circ\text{C}$ and 150°C ; $V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values.



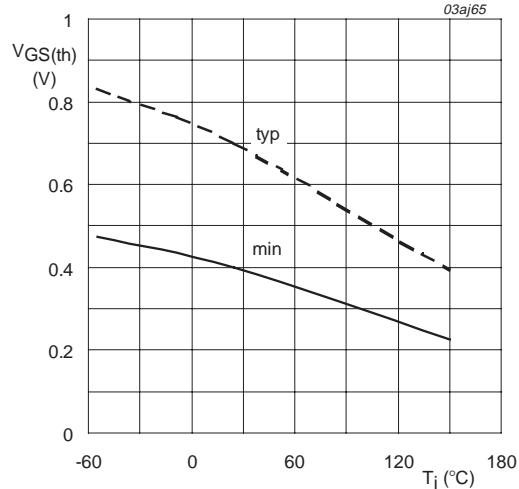
$T_j = 25^\circ\text{C}$

Fig 7. Drain-source on-state resistance as a function of drain current; typical values.



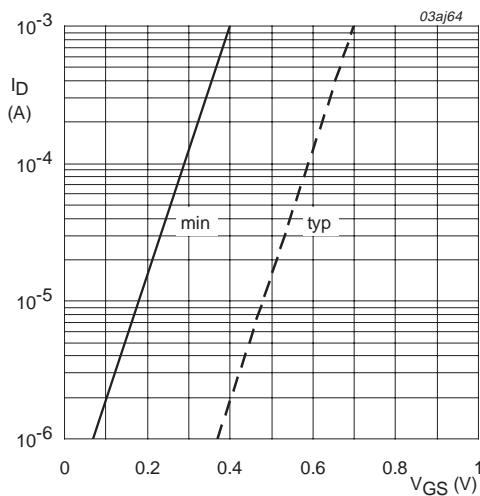
$$a = \frac{R_{DSon}}{R_{DSon}(25^\circ\text{C})}$$

Fig 8. Normalized drain-source on-state resistance factor as a function of junction temperature.



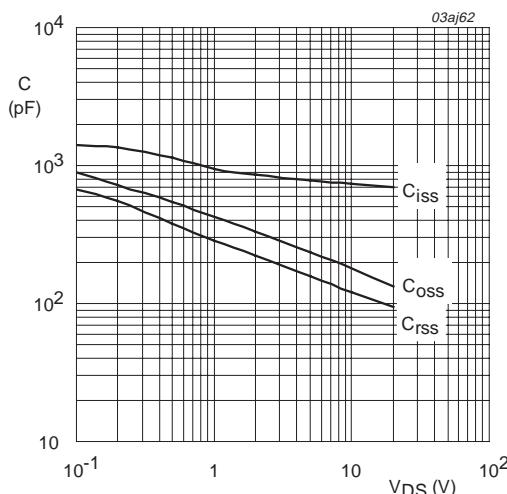
$I_D = 1$ mA; $V_{DS} = V_{GS}$

Fig 9. Gate-source threshold voltage as a function of junction temperature.



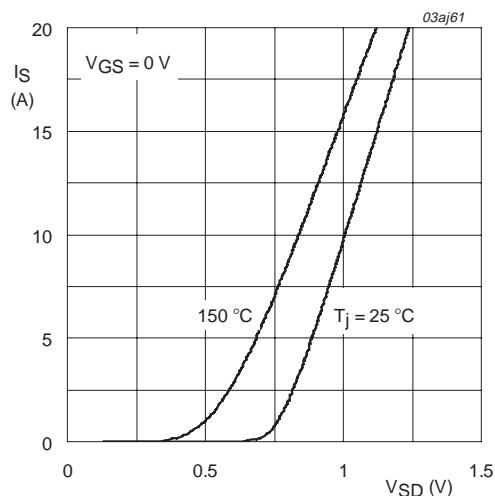
$T_j = 25$ $^{\circ}$ C; $V_{DS} = 5$ V

Fig 10. Sub-threshold drain current as a function of gate-source voltage.



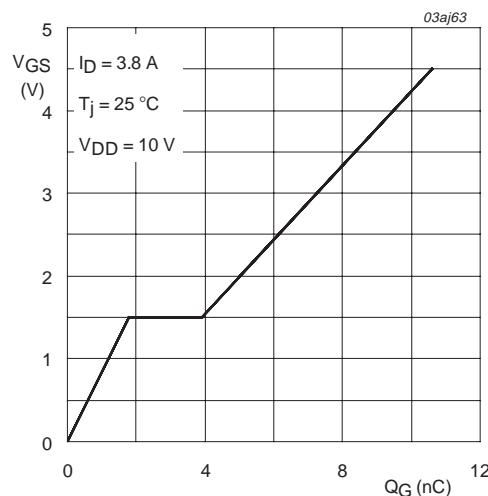
$V_{GS} = 0$ V; $f = 1$ MHz

Fig 11. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values.



$T_j = 25^\circ\text{C}$ and 150°C ; $V_{GS} = 0$ V

Fig 12. Source (diode forward) current as a function of source-drain (diode forward) voltage; typical values.



$I_D = 3.8$ A; $V_{DD} = 10$ V

Fig 13. Gate-source voltage as a function of gate charge; typical values.

9. Package outline

Plastic surface mounted package; 6 leads

SOT457

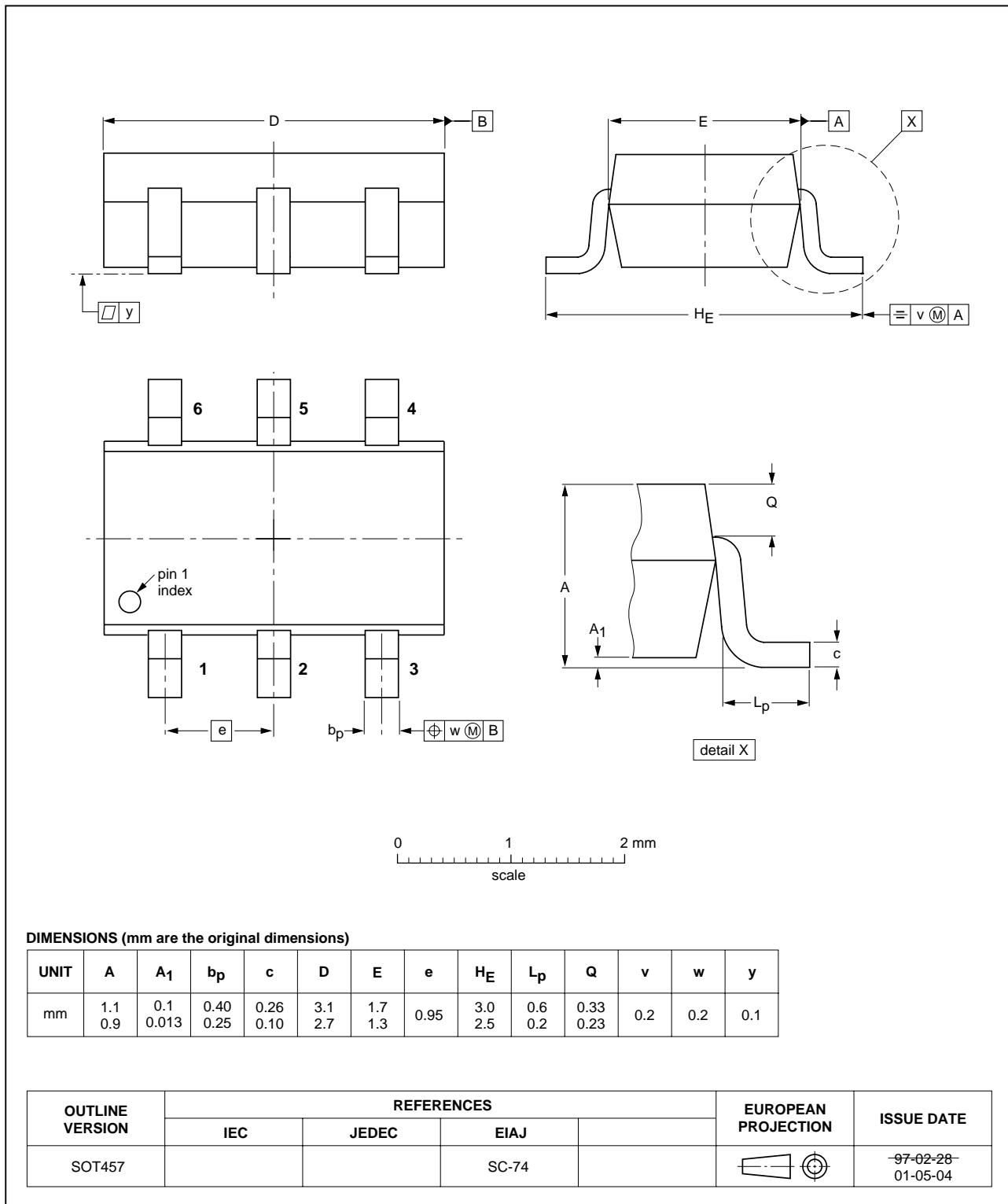


Fig 14. SOT457 (TSOP6).

10. Revision history

Table 6: Revision history

Rev	Date	CPCN	Description
01	20020927	-	Product data (9397 750 10189)

11. Data sheet status

Data sheet status ^[1]	Product status ^[2]	Definition
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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